

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MASAKO HATASE	03/30/2016
MASAKI ENZU	03/30/2016
ATSUSHI SAKURAI	03/30/2016
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15032230
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NAME OF SUBMITTER:	ERIC JENSEN
SIGNATURE:	/Eric Jensen/
DATE SIGNED:	04/26/2016
This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 1

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ASSIGNMENT AND INVENTOR'S DECLARATION

WHEREAS I/we, the undersigned inventor(s), hereafter also referred to as "assignor(s)", have invented certain new and useful improvements described in the application identified below; and

WHEREAS, ADEKA CORPORATION, hereinafter referred to as "assignee(s)", whose address is 2-35, Higashiogu 7-chome, Arakawa-ku, Tokyo 1168554 Japan, is desirous of acquiring the entire right, title and interest in and to the application and invention, and to any United States patents to be obtained therefor;

NOW, THEREFORE, for valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I/we, the above-named assignor(s), hereby sell, assign and transfer to the above named assignee(s), its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including any right to bring or maintain an action for infringement under the provisional rights granted pursuant to Title 35, Section 154 of the United States Code or any other cause of action for acts which would constitute infringement occurring prior to this assignment, and including the right to claim priority under the International Convention of Paris (1883), as amended, of or in any corresponding foreign patent application, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee(s), its successors and assigns.

As a below named inventor, I hereby declare that:

This assignment and declaration The attached application, or is directed to: United States Application or PCT International Application Number PCT/JP2014/079576 filed on November 7, 2014 (Confirmation No. _____).

The application is entitled:

"RUTHENIUM COMPOUND, MATERIAL FOR THIN FILM FORMATION, AND PROCESS FOR THIN FILM FORMATION"

The above-identified application was made or was authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this assignment with declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

Given Name(s)	Masako	Family Name/Surname(s)	HATASE
Inventor's Signature:	Masako Hatase	Date	2016. 3. 30
Given Name(s)	Masaki	Family Name/Surname(s)	ENZU
Inventor's Signature:	Masaki Enzu	Date	2016. 3. 30
Given Name(s)	Atsushi	Family Name/Surname(s)	SAKURAI
Inventor's Signature:	Atsushi Sakurai	Date	2016. 3. 30
Given Name(s)	Tomoharu	Family Name/Surname(s)	YOSHINO
Inventor's Signature:	Tomoharu Yoshino	Date	2016. 3. 30

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